

## 40V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)}$ max	$I_D$ max (A) $T_A = 25^\circ\text{C}$ (Notes 3 & 5)
40V	25m $\Omega$ @ $V_{GS} = 10\text{V}$	7.4
	40m $\Omega$ @ $V_{GS} = 4.5\text{V}$	6.2

### Description and Applications

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor control
- Backlighting
- DC-DC Converters
- Printer equipment

### Features and Benefits

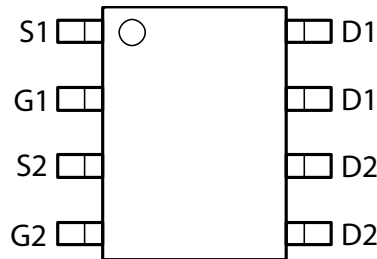
- Low  $R_{DS(on)}$  – Minimizes conduction losses
- Fast switching speed – Minimizes switching losses
- "Green" component and RoHS compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

### Mechanical Data

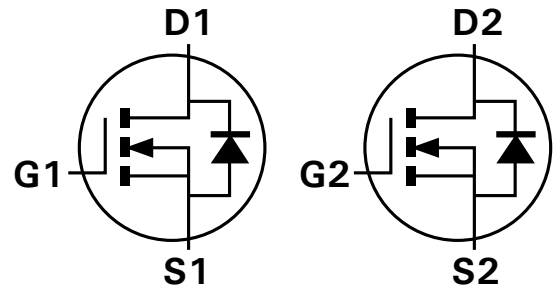
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)



Top View



Pin-Out Top View



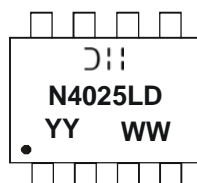
Device symbol

### Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN4025LSD-13	N4025LD	13	12	2,500

Note: 1. Diodes, Inc. defines "Green" products as those which are RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

### Marking Information



D = Manufacturer's Marking  
 N4025LD = Product Type Marking Code  
 YYWW = Date Code Marking  
 YY = Year (ex: 10 = 2010)  
 WW = Week (01 - 53)

## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

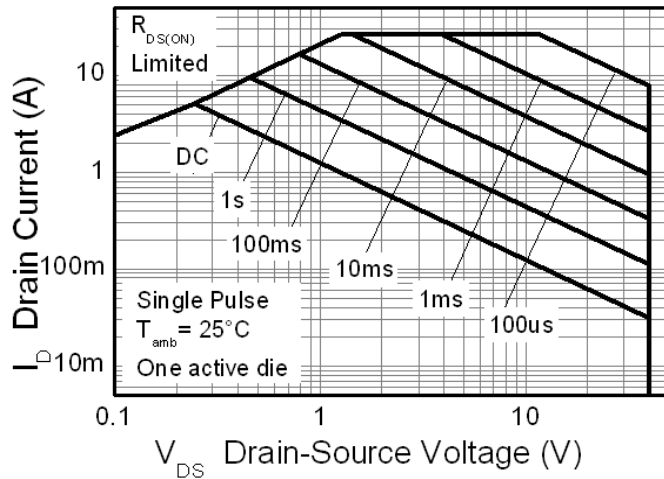
Characteristic			Symbol	Value	Units
Drain-Source Voltage			V <sub>DSS</sub>	40	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	
Continuous Drain Current	V <sub>GS</sub> = 10V	(Notes 3 & 5)	I <sub>D</sub>	7.4	A
		T <sub>A</sub> = 70°C (Notes 3 & 5)		5.8	
		(Notes 2 & 5)		5.6	
		(Notes 2 & 6)		6.7	
Pulsed Drain Current	V <sub>GS</sub> = 10V	(Notes 4 & 5)	I <sub>DM</sub>	29.0	
Continuous Source Current (Body diode)		(Notes 3 & 5)	I <sub>S</sub>	3.0	
Pulsed Source Current (Body diode)		(Notes 4 & 5)	I <sub>SM</sub>	29.0	

## Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

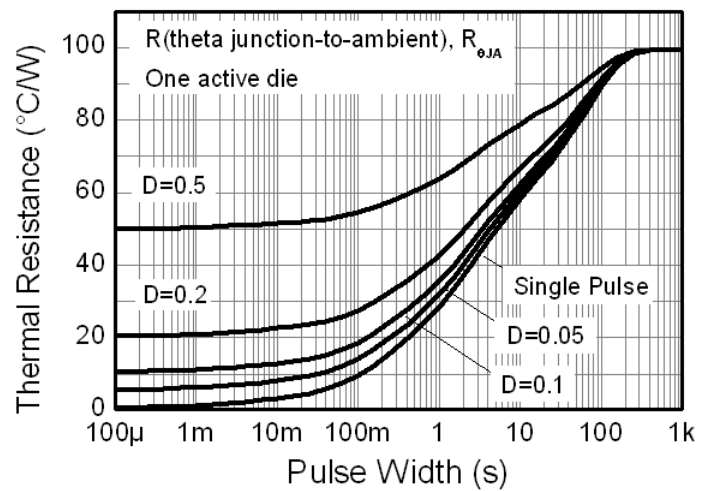
Characteristic		Symbol	Value	Unit
Power Dissipation Linear Derating Factor	(Notes 2 & 5)	P <sub>D</sub>	1.25	W mW/°C
			10	
	(Notes 2 & 6)		1.8	
	(Notes 3 & 5)		14.3	
Thermal Resistance, Junction to Ambient	(Notes 2 & 5)	R <sub>θJA</sub>	2.14	°C/W
	(Notes 2 & 6)		17.2	
	(Notes 3 & 5)		100	
Thermal Resistance, Junction to Lead	(Notes 2 & 6)	R <sub>θJL</sub>	70	°C/W
	(Notes 3 & 5)		58	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	51	°C

- Notes:
2. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
  3. Same as note (2), except the device is measured at t ≤ 10 sec.
  4. Same as note (2), except the device is pulsed with D = 0.02 and pulse width 300μs.
  5. For a dual device with one active die.
  6. For a device with two active die running at equal power.
  7. Thermal resistance from junction to solder-point (at the end of the drain lead).

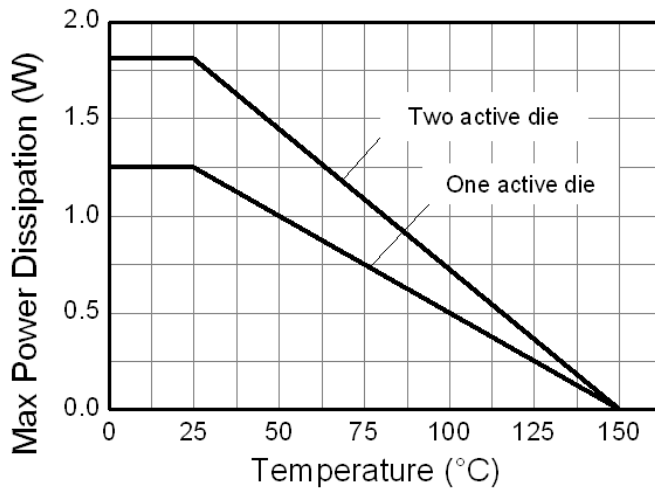
## Thermal Characteristics



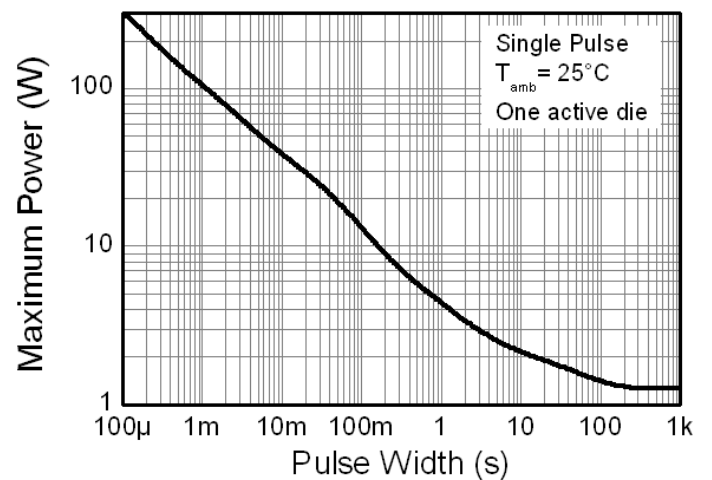
**N-channel Safe Operating Area**



**Transient Thermal Impedance**



**Derating Curve**

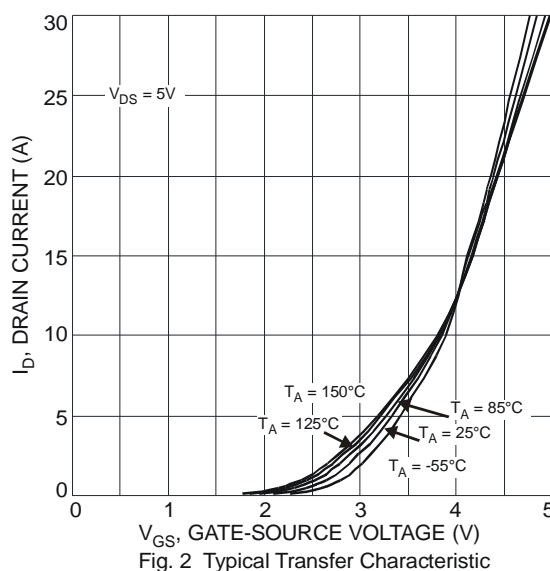
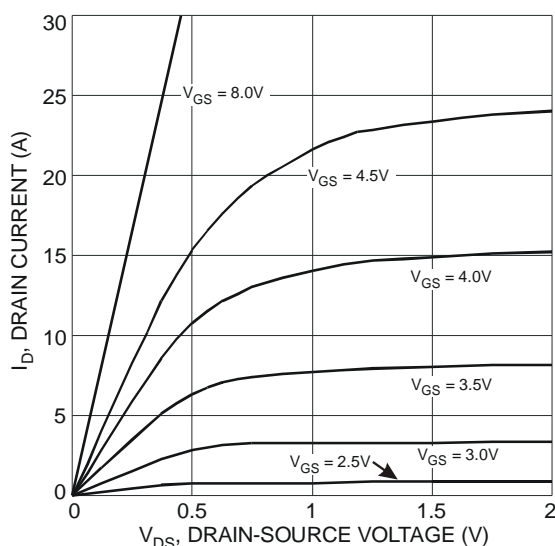


**Pulse Power Dissipation**

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	40	—	—	V	$I_D = 250\mu\text{A}$ , $V_{GS} = 0\text{V}$
Zero Gate Voltage Drain Current	$I_{DSS}$	—	—	1.0	$\mu\text{A}$	$V_{DS} = 40\text{V}$ , $V_{GS} = 0\text{V}$
Gate-Source Leakage	$I_{GSS}$	—	—	$\pm 100$	nA	$V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(th)}$	0.8	1.3	1.8	V	$I_D = 250\mu\text{A}$ , $V_{DS} = V_{GS}$
Static Drain-Source On-Resistance (Note 8)	$R_{DS(on)}$	—	0.013	0.025	$\Omega$	$V_{GS} = 10\text{V}$ , $I_D = 3\text{A}$
			0.028	0.040		$V_{GS} = 4.5\text{V}$ , $I_D = 3\text{A}$
Forward Transconductance (Notes 8 & 9)	$g_{fs}$	—	12.6	—	S	$V_{DS} = 5\text{V}$ , $I_D = 3\text{A}$
Diode Forward Voltage (Note 8)	$V_{SD}$	—	0.7	1.0	V	$I_S = 1\text{A}$ , $V_{GS} = 0\text{V}$
<b>DYNAMIC CHARACTERISTICS (Note 9)</b>						
Input Capacitance	$C_{iss}$	—	1790	—	pF	$V_{DS} = 20\text{V}$ , $V_{GS} = 0\text{V}$ $f = 1\text{MHz}$
Output Capacitance	$C_{oss}$	—	160	—		
Reverse Transfer Capacitance	$C_{rss}$	—	120	—		
Gate Resistance	$R_g$	—	1.03	—	$\Omega$	$V_{DS} = 0\text{V}$ , $V_{GS} = 0\text{V}$ , $f = 1\text{MHz}$
Total Gate Charge (Note 10)	$Q_g$	—	16.0	—	nC	$V_{GS} = 4.5\text{V}$ $V_{DS} = 20\text{V}$ $I_D = 3\text{A}$
Total Gate Charge (Note 10)	$Q_g$	—	37.6	—		
Gate-Source Charge (Note 10)	$Q_{gs}$	—	7.8	—		
Gate-Drain Charge (Note 10)	$Q_{gd}$	—	6.6	—		
Turn-On Delay Time (Note 10)	$t_{D(on)}$	—	8.1	—	ns	$V_{DD} = 20\text{V}$ , $V_{GS} = 10\text{V}$ $I_D = 3\text{A}$
Turn-On Rise Time (Note 10)	$t_r$	—	15.1	—		
Turn-Off Delay Time (Note 10)	$t_{D(off)}$	—	24.3	—		
Turn-Off Fall Time (Note 10)	$t_f$	—	5.3	—		

Notes: 8. Measured under pulsed conditions. Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .  
 9. For design aid only, not subject to production testing.  
 10. Switching characteristics are independent of operating junction temperatures.

**Typical Characteristics**


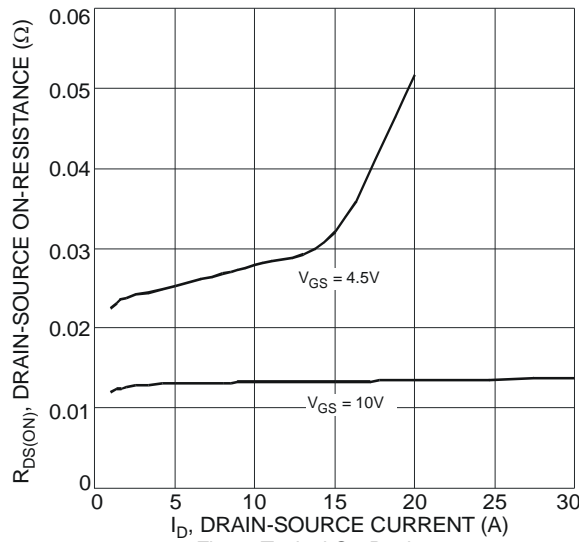


Fig. 3 Typical On-Resistance  
vs. Drain Current and Gate Voltage

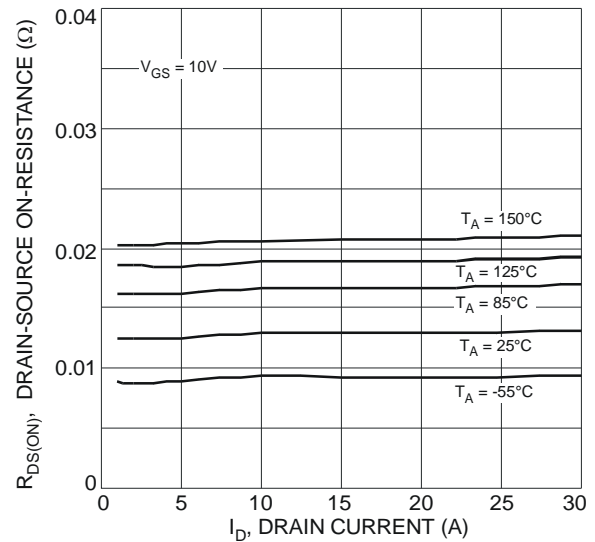


Fig. 4 Typical On-Resistance  
vs. Drain Current and Temperature

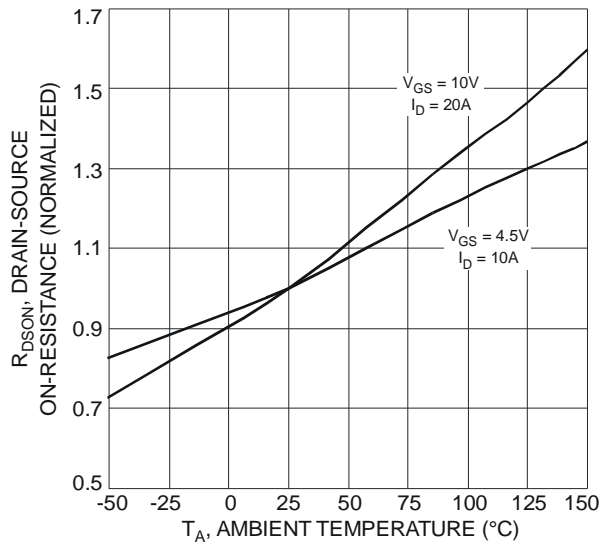


Fig. 5 On-Resistance Variation with Temperature

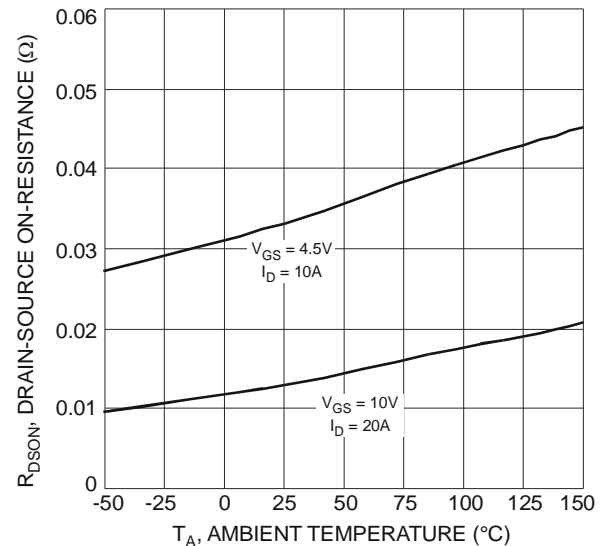


Fig. 6 On-Resistance Variation with Temperature

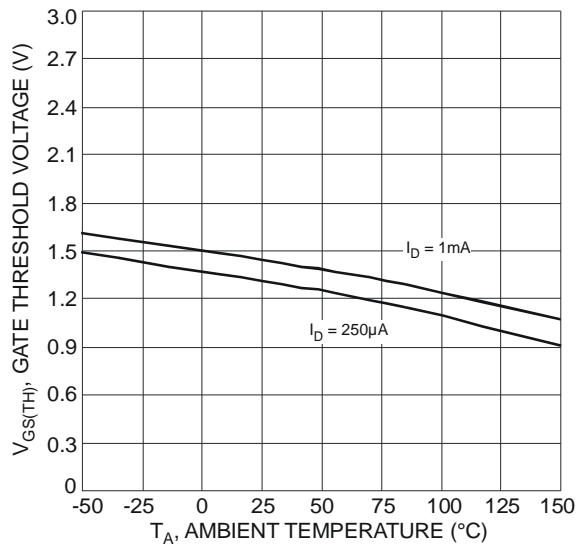


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

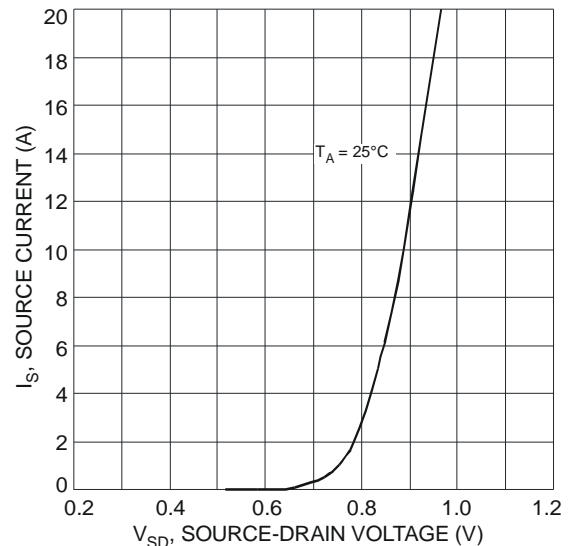


Fig. 8 Diode Forward Voltage vs. Current

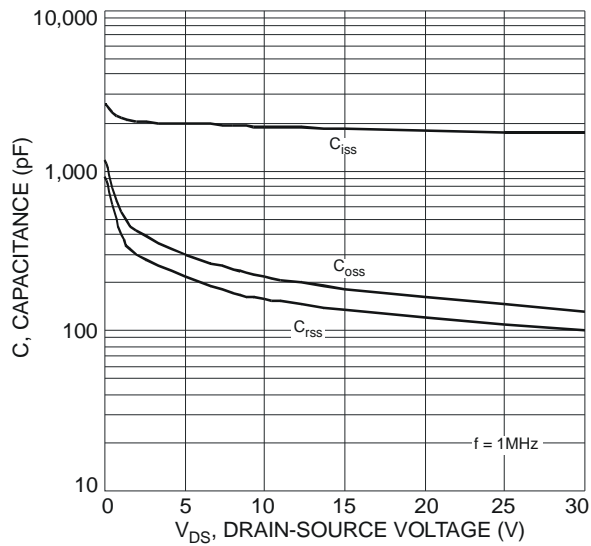


Fig. 9 Typical Total Capacitance

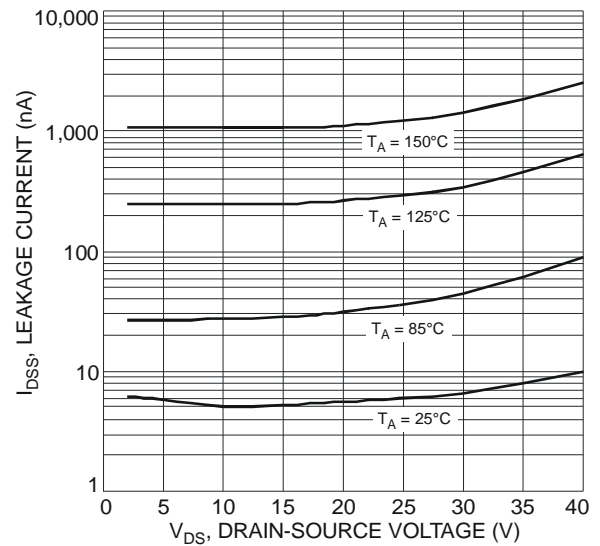


Fig. 10 Typical Leakage Current  
vs. Drain-Source Voltage

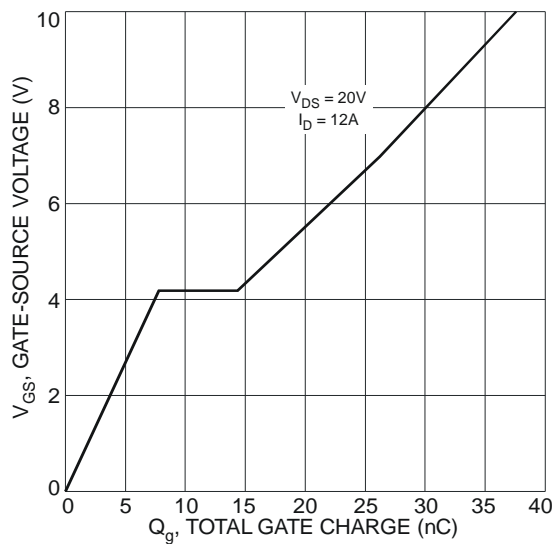
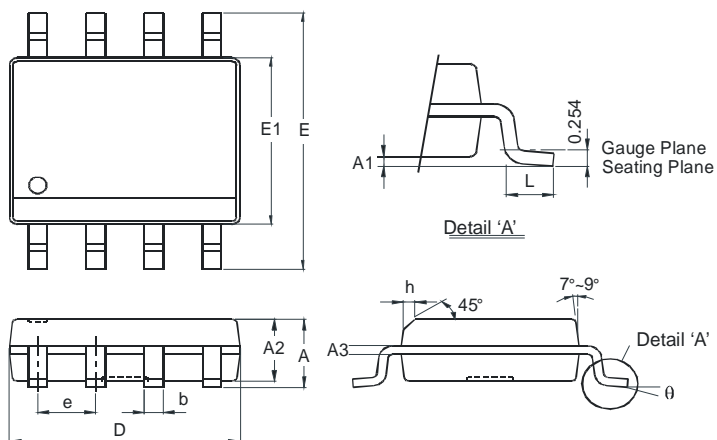


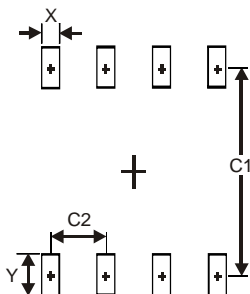
Fig. 11 Gate-Charge Characteristics

## Package Outline Dimensions



SO-8		
Dim	Min	Max
<b>A</b>	-	1.75
<b>A1</b>	0.10	0.20
<b>A2</b>	1.30	1.50
<b>A3</b>	0.15	0.25
<b>b</b>	0.3	0.5
<b>D</b>	4.85	4.95
<b>E</b>	5.90	6.10
<b>E1</b>	3.85	3.95
<b>e</b>	1.27 Typ	
<b>h</b>	-	0.35
<b>L</b>	0.62	0.82
<b>θ</b>	0°	8°
All Dimensions in mm		

## Suggested Pad Layout



Dimensions	Value (in mm)
<b>X</b>	0.60
<b>Y</b>	1.55
<b>C1</b>	5.4
<b>C2</b>	1.27

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